QIAOXIN N-ChannelEnhancement Mode Power MOSFET

Description

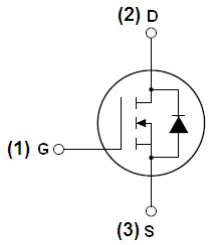
The VCRR82H160D uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

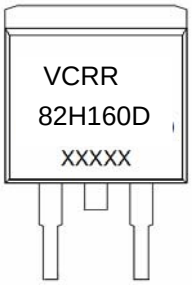
- V_{DS} = 82V,I_D =160A
  $R_{DS(ON)}$ < 4.5mΩ @ V_{GS}=10V (Typ:3.6mΩ)
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



Schematic diagram



Marking and pin assignment

TO-263-2L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VCRR82H160D		TO-263-2L		-	-

Absolute Maximum Ratings (T_C=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	82	V
Gate-Source Voltage	V_{GS}	±20	V
Drain Current-Continuous	I_D	160	A
Drain Current-Continuous(T_C=100℃)	I_D (100℃)	113	A
Pulsed Drain Current	I_{DM}	640	A
Maximum Power Dissipation	P_D	285	W
Derating factor		1.9	W/℃
Single pulse avalanche energy (Note 5)	E_{AS}	1656	mJ
Operating Junction and Storage Temperature Range	T_J,T_{STG}	-55 To 175	℃

Thermal Characteristic

Thermal Resistance,Junction-to-Case (Note 2)	$R_{\theta Jc}$	0.53	℃/W

Electrical Characteristics (T_C=25℃unless otherwise noted)

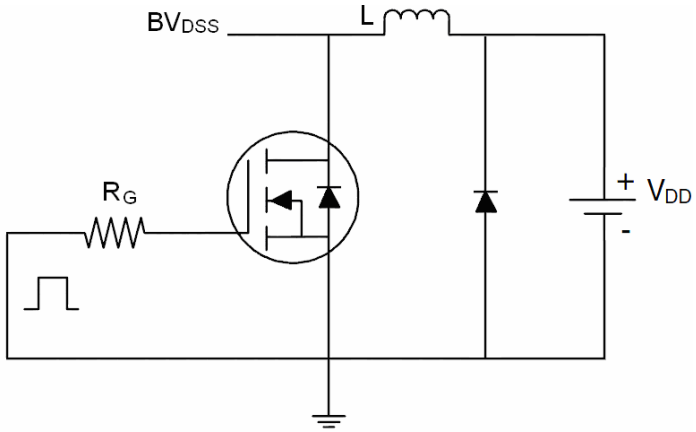
Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V I_D=250μA	82	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=82V,V_{GS}=0V	-	-	1	μA
Gate-Body Leakage Current	I_{GSS}	V_{GS}=±20V,V_{DS}=0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS},I_D=250μA	2	3	4	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	V_{GS}=10V, I_D=20A	-	3.6	4.5	mΩ
Forward Transconductance	g_{FS}	V_{DS}=5V,I_D=20A	75	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C_{lss}	V_{DS}=40V,V_{GS}=0V, F=1.0MHz	-	11180	-	PF
Output Capacitance	C_{oss}		-	537	-	PF
Reverse Transfer Capacitance	C_{rss}		-	461	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	$t_{d(on)}$	V_{DD}=40V, R_L=2Ω V_{GS}=10V,R_{GEN}=2.5Ω	-	30	-	nS
Turn-on Rise Time	t_r		-	48	-	nS
Turn-Off Delay Time	$t_{d(off)}$		-	82	-	nS
Turn-Off Fall Time	t_f		-	35	-	nS
Total Gate Charge	Q_g	V_{DS}=40V,I_D=20A, V_{GS}=10V	-	201	-	nC
Gate-Source Charge	Q_{gs}		-	47	-	nC
Gate-Drain Charge	Q_{gd}		-	60	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V_{SD}	V_{GS}=0V,I_S=160A	-	-	1.2	V
Diode Forward Current (Note 2)	I_S	-	-	-	160	A
Reverse Recovery Time	t_{rr}	TJ = 25°C, IF = 20A di/dt = 100A/μs (Note3)	-	70	-	nS
Reverse Recovery Charge	Qrr		-	140	-	nC

Notes:

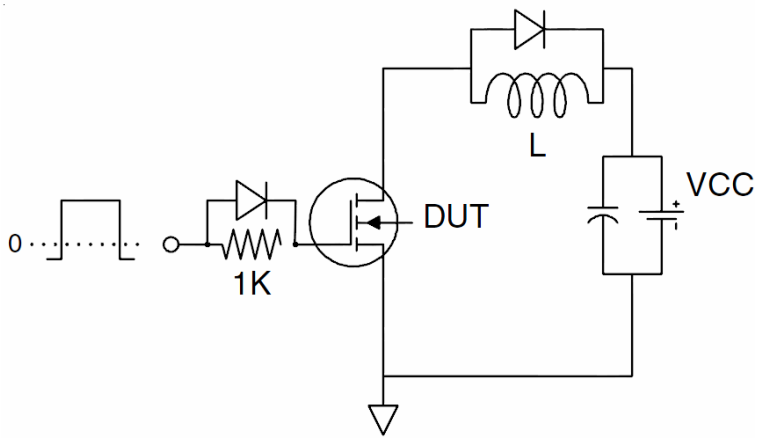
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production
5. EAS condition：Tj=25℃,VDD=40V,VG=10V,L=0.5mH,Rg=25Ω

Test circuit

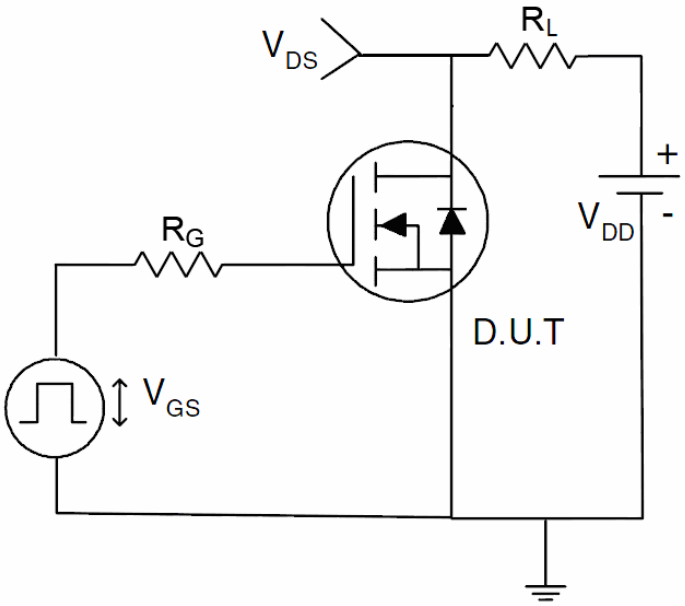
1）E_{AS} test Circuit



2）Gate charge test Circuit



3）Switch Time Test Circuit



Typical Electrical and Thermal Characteristics (Curves)

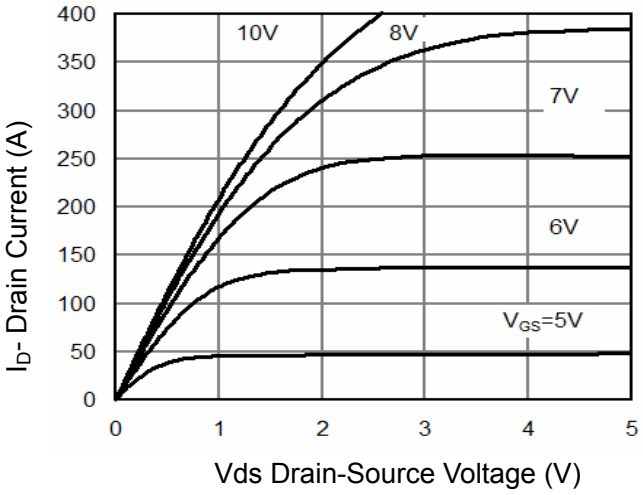


Figure 1 Output Characteristics

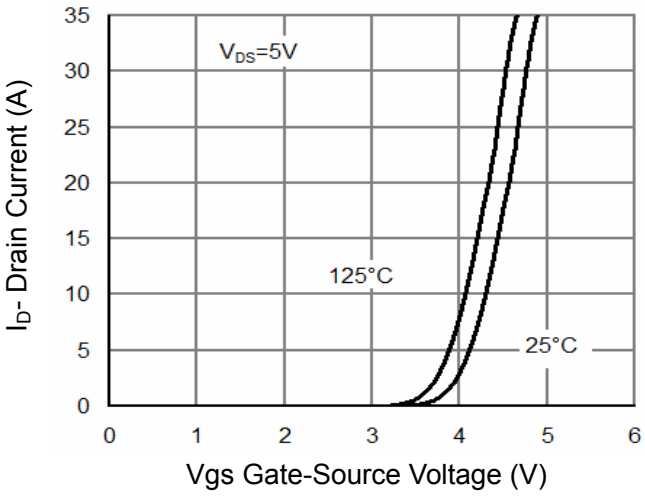


Figure 2 Transfer Characteristics

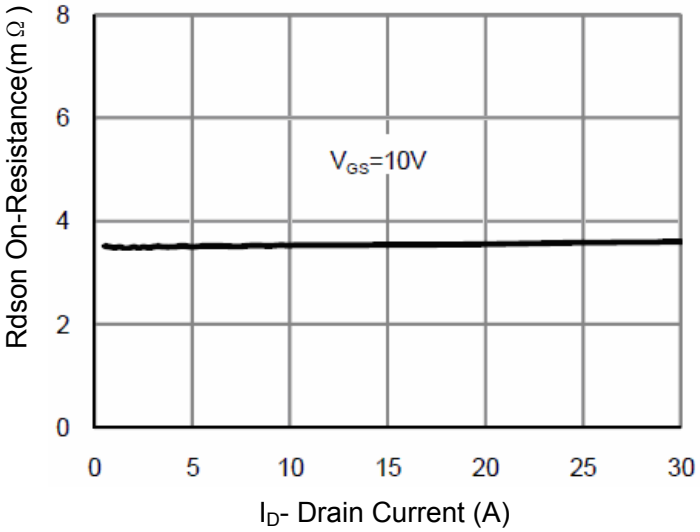


Figure 3 Rdson- Drain Current

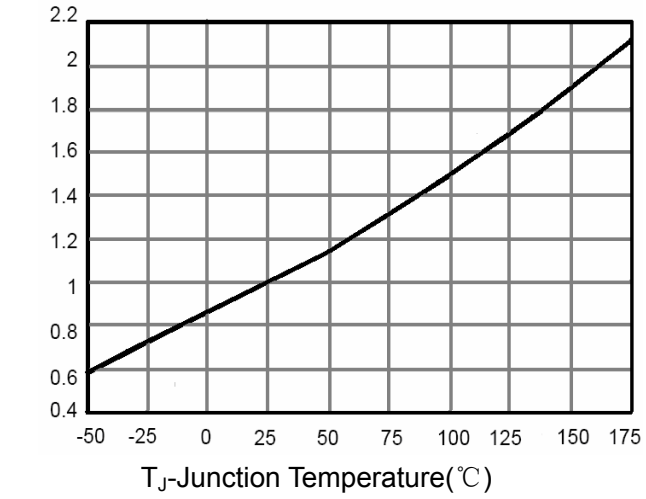


Figure 4 Rdson-JunctionTemperature

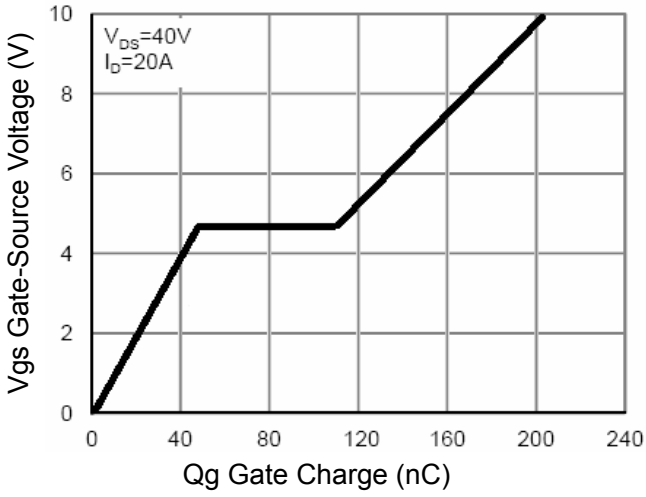


Figure 5 Gate Charge

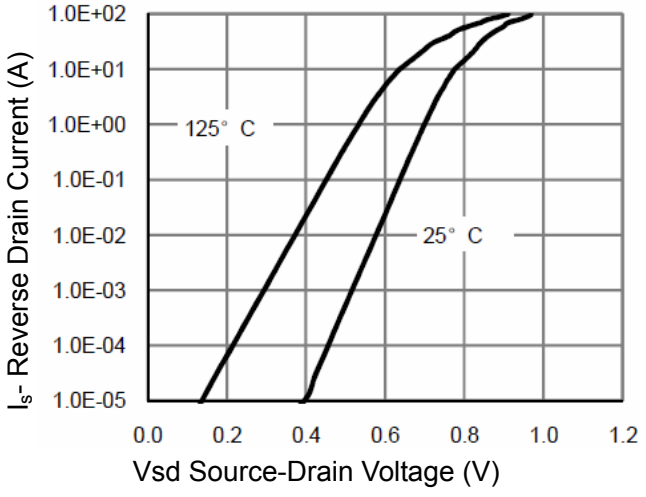


Figure 6 Source- Drain Diode Forward

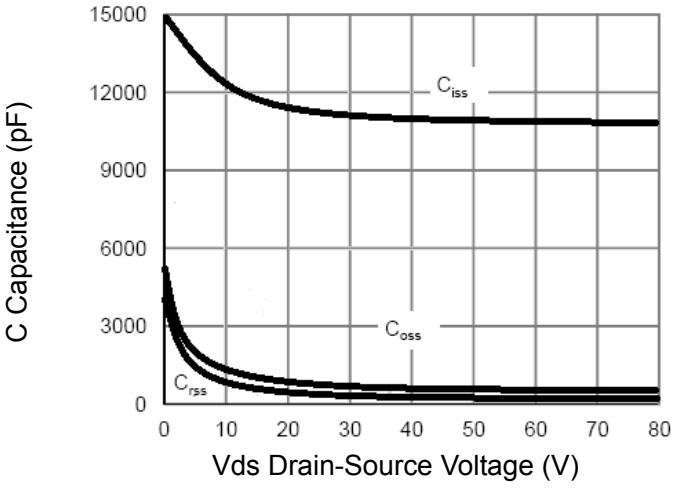


Figure 7 Capacitance vs Vds

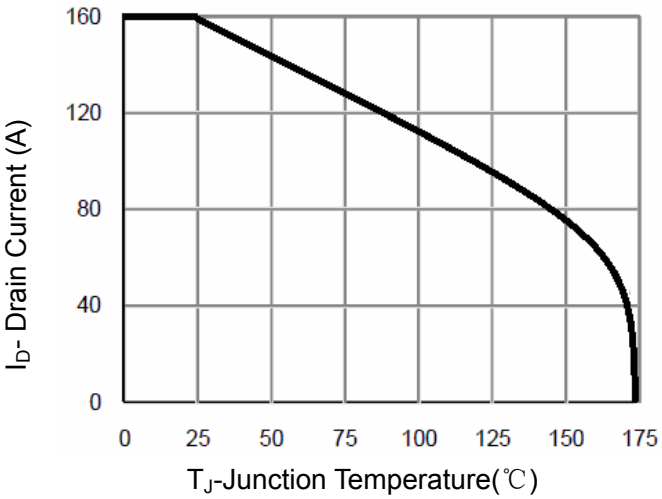


Figure 9 Current De-rating

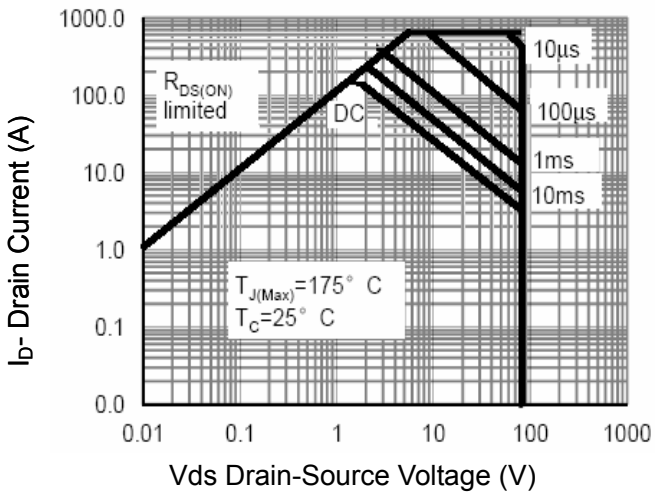


Figure 8 Safe Operation Area

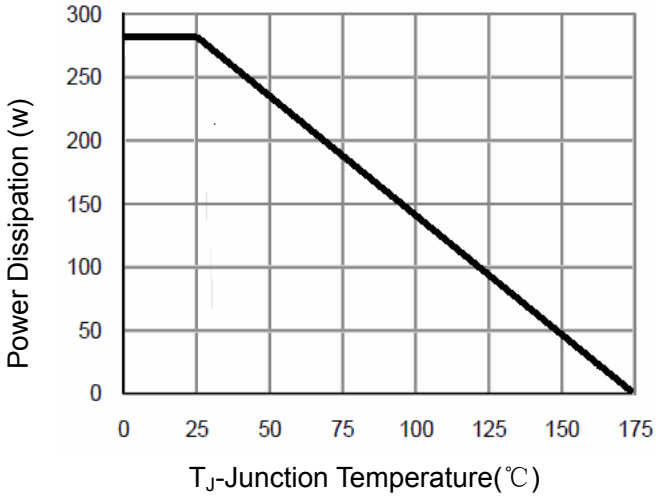


Figure 10 Power De-rating

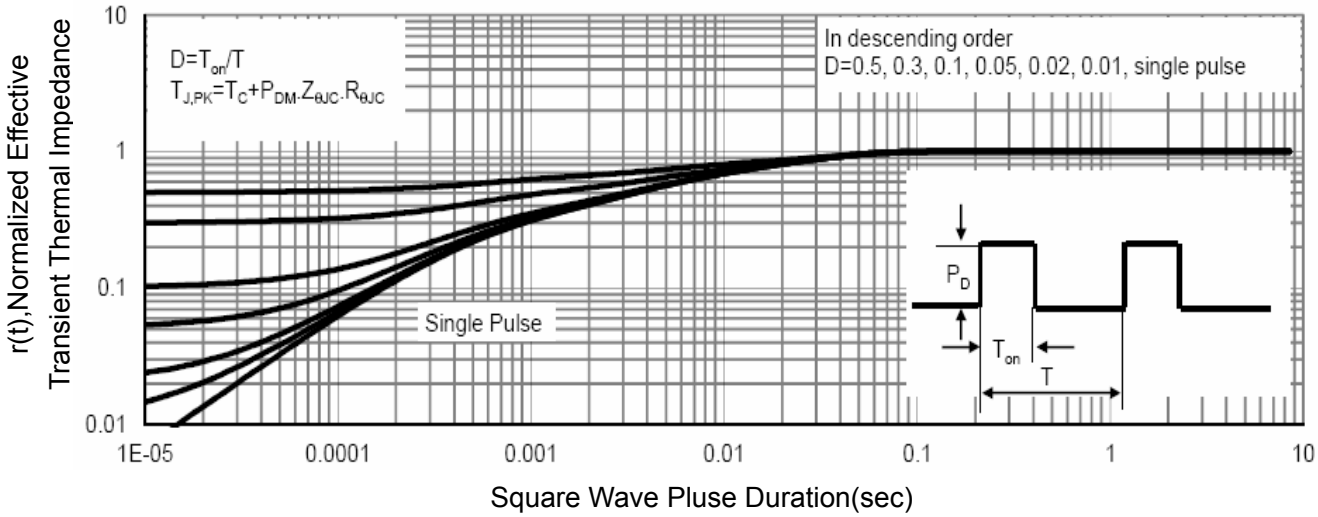
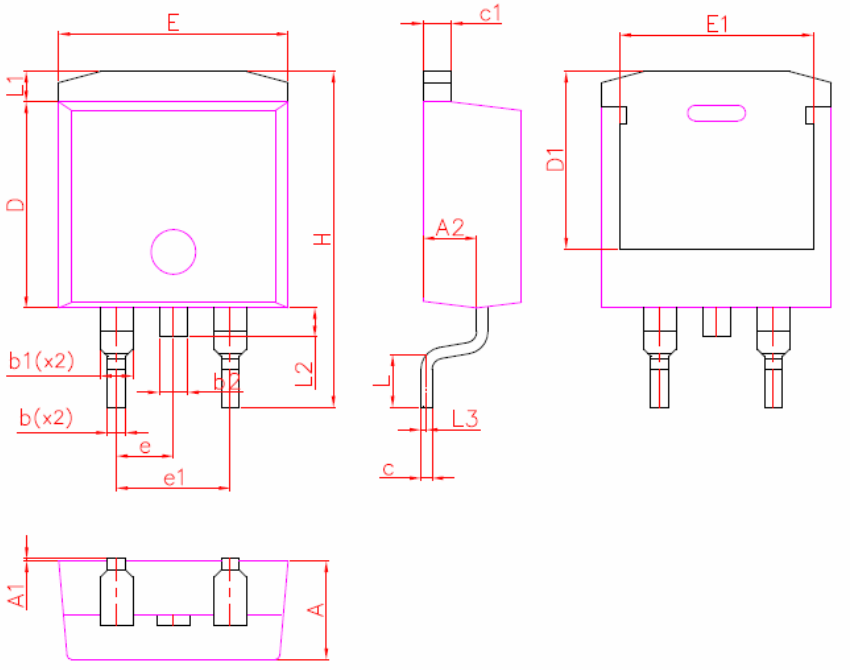


Figure 11 Normalized Maximum Transient Thermal Impedance

TO-263-2L Package Information



TO263			
DIM.	MIN.	NOM.	MAX.
A	4.20	4.40	4.60
A1	0.00	0.10	0.25
A2	2.20	2.40	2.60
b	0.70	0.80	0.90
b1	1.20	1.45	1.75
b2	1.17	1.27	1.37
c	0.40	0.50	0.60
c1	1.15	1.27	1.40
D	9.10	9.20	9.30
D1	7.63	7.93	8.23
E	10.05	10.25	10.45
E1	8.35	8.65	8.95
e	2.54BSC		
e1	5.08BSC		
H	14.61	15.00	15.88
L	1.78	2.35	2.79
L1	1.36REF		
L2	1.3REF		
L3	0.25REF		
All dimensions in millimeters			

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